



# CEM8433

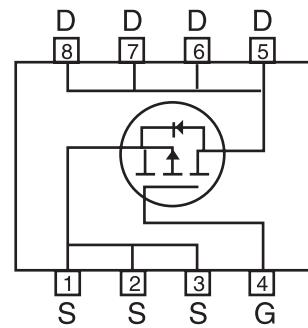
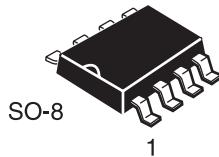
March 1998

## P-Channel Enhancement Mode Field Effect Transistor

### FEATURES

5

- -20V , -5.2A ,  $R_{DS(ON)}=55m\Omega$  @  $V_{GS}=-4.5V$ .
- $R_{DS(ON)}=95m\Omega$  @  $V_{GS}=-2.5V$ .
- Super high dense cell design for extremely low  $R_{DS(ON)}$ .
- High power and current handing capability.
- Surface Mount Package.



### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	-20	V
Gate-Source Voltage	V <sub>GS</sub>	$\pm 8$	V
Drain Current-Continuous <sup>a</sup> @ T <sub>J</sub> =125°C -Pulsed <sup>b</sup>	I <sub>D</sub>	$\pm 5.2$	A
	I <sub>DM</sub>	$\pm 20$	A
Drain-Source Diode Forward Current <sup>a</sup>	I <sub>S</sub>	-2.1	A
Maximum Power Dissipation <sup>a</sup>	P <sub>D</sub>	2.5	W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient <sup>a</sup>	R <sub>θ JA</sub>	50	°C/W
--	-------------------	----	------

# CEM8433

## ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

5

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA	-20			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-16V, V <sub>GS</sub> =0V			-1	μA
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V			±100	nA
<b>ON CHARACTERISTICS<sup>b</sup></b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-0.4	-0.8	-1	V
Drain-Source On-State Resistance	R <sub>D(S)ON</sub>	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-5.2A		49	55	mΩ
		V <sub>GS</sub> =-2.5V, I <sub>D</sub> =-2.0A		91	95	mΩ
On-State Drain Current	I <sub>D(ON)</sub>	V <sub>DS</sub> =-5V, V <sub>GS</sub> =-4.5V	-10			A
Forward Transconductance	g <sub>F</sub>	V <sub>DS</sub> =-10V, I <sub>D</sub> =-5.2A		9		S
<b>DYNAMIC CHARACTERISTICS<sup>c</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-10V, V <sub>GS</sub> =0V f=1.0MHz		1420	2000	pF
Output Capacitance	C <sub>oss</sub>			670	1000	pF
Reverse Transfer Capacitance	C <sub>rss</sub>			210	600	pF
<b>SWITCHING CHARACTERISTICS<sup>c</sup></b>						
Turn-On Delay Time	t <sub>D(ON)</sub>	V <sub>D</sub> =-5V, I <sub>D</sub> =-1A, V <sub>GS</sub> =-4.5V, R <sub>GEN</sub> =6Ω		12	30	ns
Rise Time	t <sub>r</sub>			45	60	ns
Turn-Off Delay Time	t <sub>D(OFF)</sub>			70	150	ns
Fall Time	t <sub>f</sub>			30	80	ns
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-5V, I <sub>D</sub> =-5.2A, V <sub>GS</sub> =-4.5V		25	40	nC
Gate-Source Charge	Q <sub>gs</sub>			4		nC
Gate-Drain Charge	Q <sub>gd</sub>			8		nC

# CEM8433

5

## ELECTRICAL CHARACTERISTICS ( $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ <sup>c</sup>	Max	Unit
<b>DRAIN-SOURCE DIODE CHARACTERISTICS <sup>b</sup></b>						
Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0V, I_S = -2.1A$		-0.7	-1.2	V

### Notes

- a. Surface Mounted on FR4 Board,  $t \leq 10\text{ sec}$ .
- b. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
- c. Guaranteed by design, not subject to production testing.

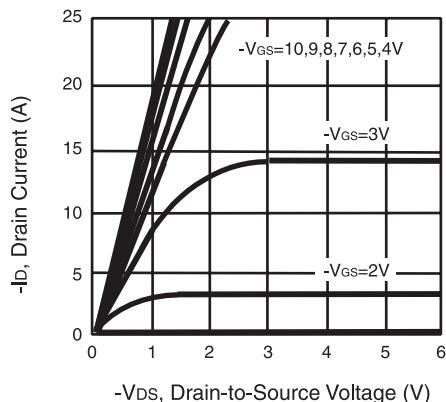


Figure 1. Output Characteristics

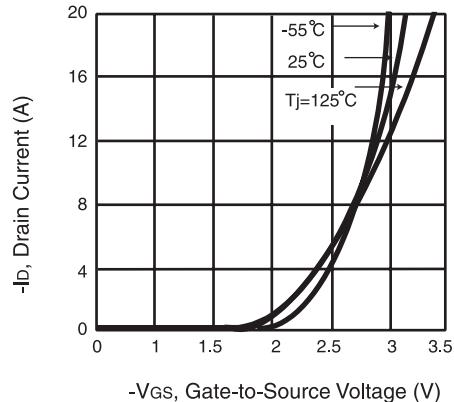


Figure 2. Transfer Characteristics

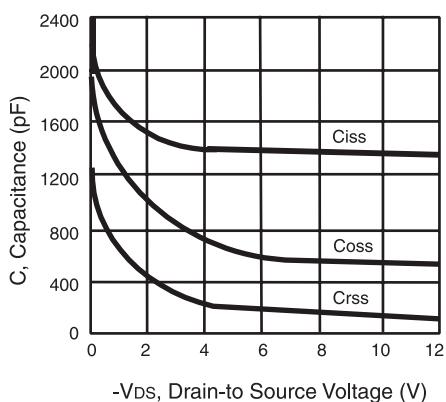


Figure 3. Capacitance

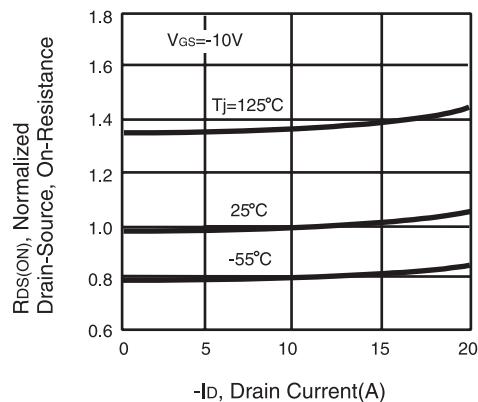
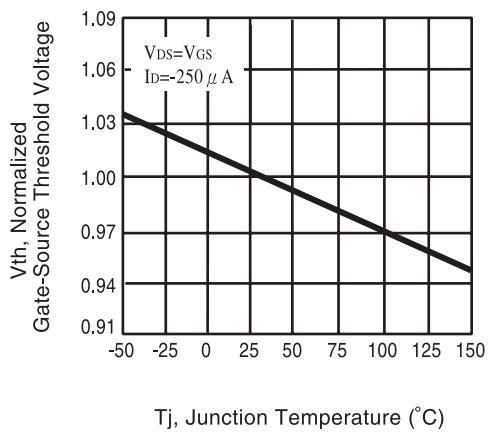


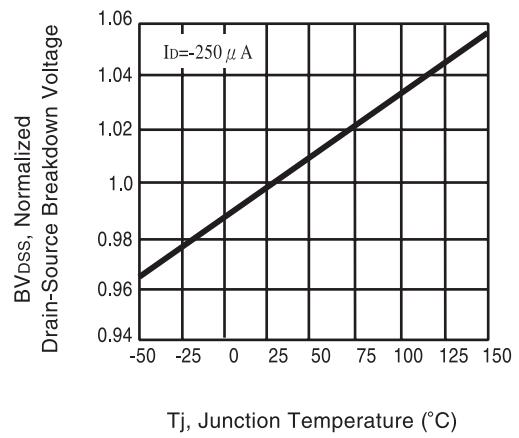
Figure 4. On-Resistance Variation with Drain Current and Temperature

# CEM8433

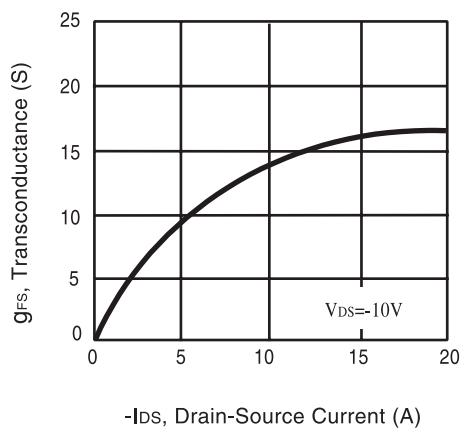
5



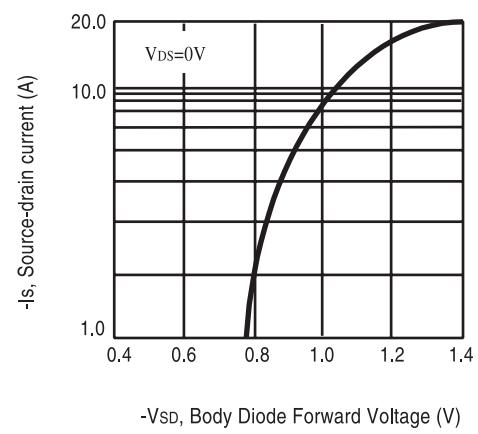
**Figure 5. Gate Threshold Variation with Temperature**



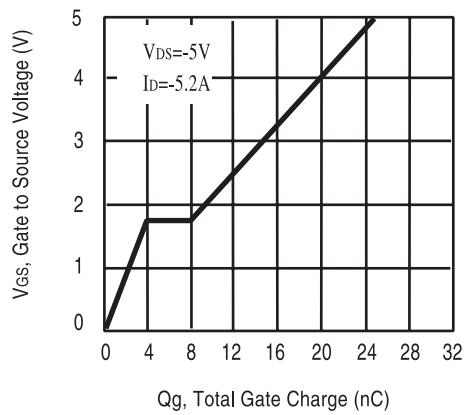
**Figure 6. Breakdown Voltage Variation with Temperature**



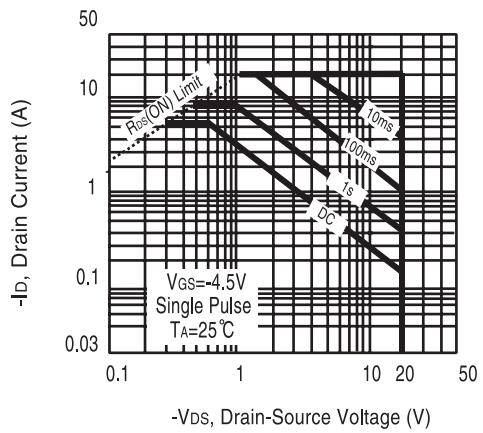
**Figure 7. Transconductance Variation with Drain Current**



**Figure 8. Body Diode Forward Voltage Variation with Source Current**



**Figure 9. Gate Charge**



**Figure 10. Maximum Safe Operating Area**

# CEM8433

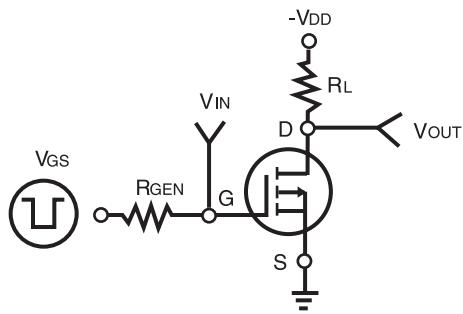
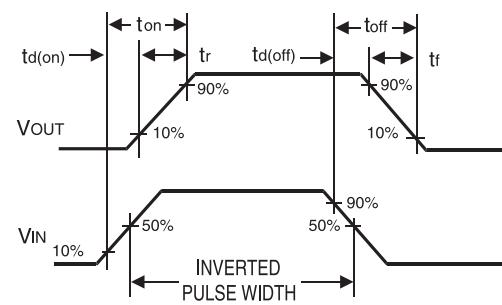


Figure 11. Switching Test Circuit



5

Figure 12. Switching Waveforms

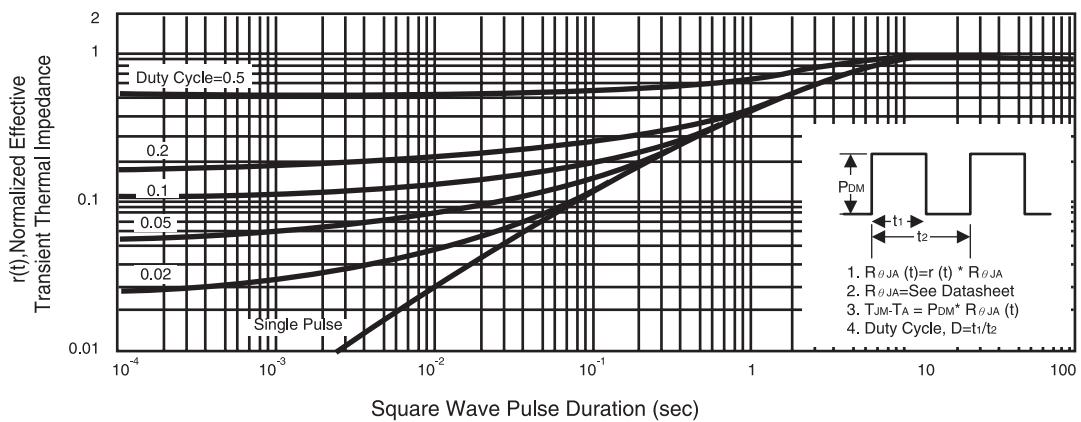


Figure 13. Normalized Thermal Transient Impedance Curve